

N AND P-CHANNEL ENHANCEMENT MODE POWER MOSFET N 加 P 沟道增强型 MOS 管

N-CH V_{DS} = 60V

R_{DSON}, V_{GS}@10V, I_{DS}@4.5A = 48mΩ

R_{DSON}, V_{GS}@4.5V, I_{DS}@3A = 60mΩ

P-CH V_{DS} = -60V

R_{DSON}, V_{GS}@-10V, I_{DS}@-3.2A = 110mΩ

R_{DSON}, V_{GS}@-4.5V, I_{DS}@-2.8A = 140mΩ

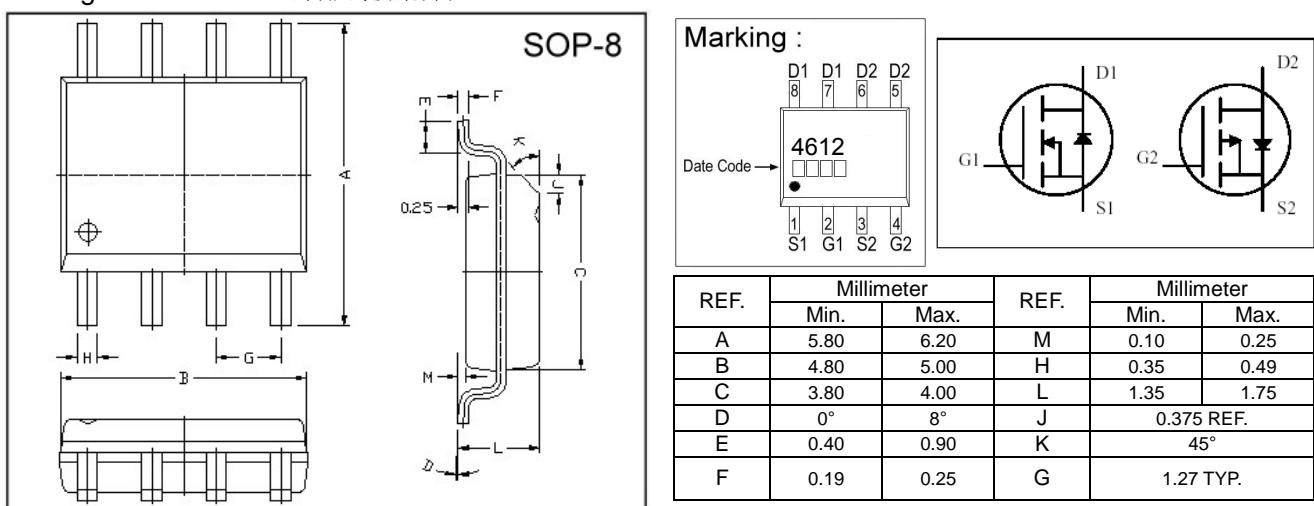
Features 特性

Advanced trench process technology 高级的加工技术

High Density Cell Design For Ultra Low On-Resistance 极低的导通电阻高密度的单元设计

Improved Shoot-Through FOM 改良的成形工艺

Package Dimensions 封装尺寸及外形图



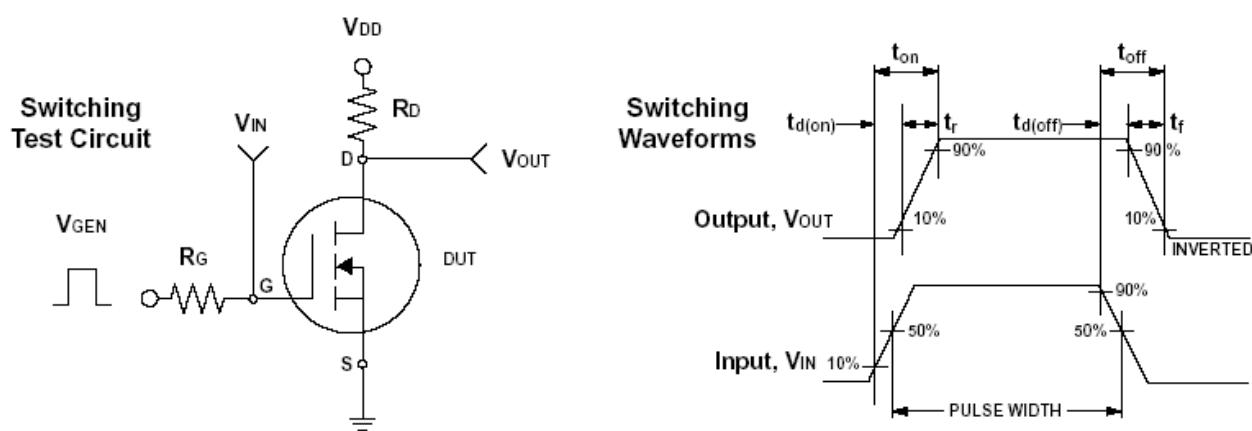
Maximum Ratings and Thermal Characteristics (TA = 25°C unless otherwise noted) 25 °C 极限参数和热特性

Parameter 极限参数	Symbol 符号	Ratings 等级		Unit 单位
		N-沟道	P-沟道	
Drain-Source Voltage 漏源电压	V _{DS}	60	-60	V
Gate-Source Voltage 栅源电压	V _{GS}	±20	±20	V
Continuous Drain Current 连续漏极电流	I _D @ TA=25°C	4.5	-3.2	A
Continuous Drain Current 连续漏极电流	I _D @ TA=70°C	3.6	-2.6	A
Pulsed Drain Current 脉冲漏极电流	I _{DM}	20	-20	A
Total Power Dissipation 功耗	P _D @ TA=25°C	2.0		W
Linear Derating Factor 线性因子		0.016		W/°C
Operating Junction and Storage Temperature Range 使用及储存温度	T _j , T _{stg}	-55 ~ +150		°C

N-Channel Electrical Characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified) N 沟道电气特性 25°C

Parameter 参数	符号	Test Condition 测试条件	最小值	典型值	最大值	单位
Static 静态参数						
Drain-Source Breakdown Voltage 漏源击穿电压	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	60			V
Drain-Source On-State Resistance 漏源导通电阻	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 4.5\text{A}$		38.0	48.0	$\text{m}\Omega$
Drain-Source On-State Resistance 漏源导通电阻	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 4.5\text{V}, I_{\text{D}} = 3.0\text{A}$		42.0	60.0	
Gate Threshold Voltage 开启电压	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	1	1.65	3	V
Zero Gate Voltage Drain Current 零栅压漏极电流	I_{DSS}	$V_{\text{DS}} = 48\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate Body Leakage 漏极短路时截止栅电流	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	nA
Forward Transconductance 正向跨导	g_{fs}	$V_{\text{DS}} = 5\text{V}, I_{\text{D}} = 4.5\text{A}$		17		S
Dynamic 动态参数						
Total Gate Charge 栅极总电荷	Q_g	$V_{\text{DS}} = 30\text{V}, I_{\text{D}} = 4.5\text{A}$ $V_{\text{GS}} = 10\text{V}$		13	25	nC
Gate-Source Charge 栅-源极电荷	Q_{gs}			1.2	2.0	
Gate-Drain Charge 栅-漏极电荷	Q_{gd}			5.8	11	
Turn-On Delay Time 导通延迟时间	$t_{\text{d(on)}}$	$V_{\text{DD}} = 30\text{V}, R_L = 20\Omega$ $V_{\text{GEN}} = 10\text{V}$ $R_G = 3\Omega$		9.8		ns
Turn-On Rise Time 导通上升时间	t_r			4.4		
Turn-Off Delay Time 关断延迟时间	$t_{\text{d(off)}}$			37		
Turn-Off Fall Time 关断下降时间	t_f			5		
Input Capacitance 输入电容	C_{iss}	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 0\text{V}$ $f = 1.0\text{ MHz}$		655		pF
Output Capacitance 输出电容	C_{oss}			53		
Reverse Transfer Capacitance 反向传输电容	C_{rss}			28.5		
Source-Drain Diode 源漏二极管参数						
Max. Diode Forward Current 最大正向电流	I_s				3.8	A
Diode Forward Voltage 正向电压	V_{SD}	$I_s = 1\text{A}, V_{\text{GS}} = 0\text{V}$			1	V

Note: Pulse test: pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$ 注意: 脉冲测试: 脉冲宽度 $\leq 300\text{us}$ 死区 $\leq 2\%$



N-Channel Characteristics Curve N 沟道电气性能特征曲线

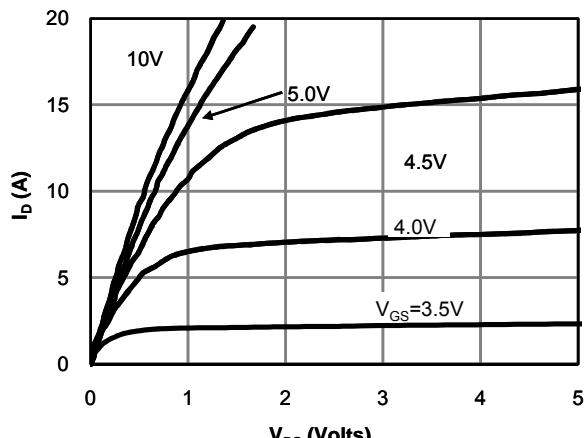


Fig 1: On-Region Characteristics

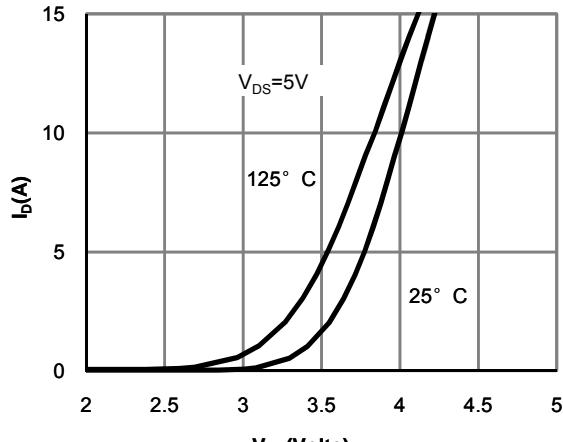


Figure 2: Transfer Characteristics

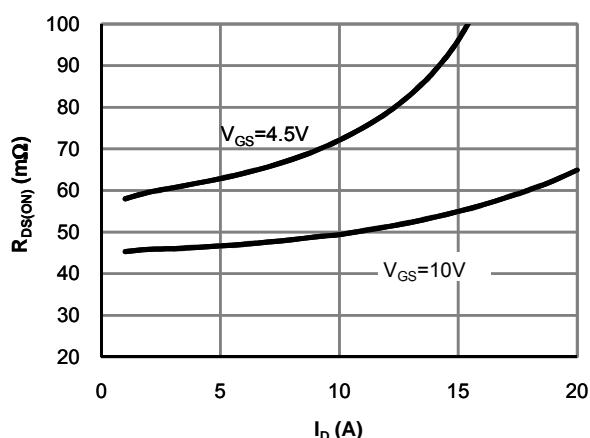


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

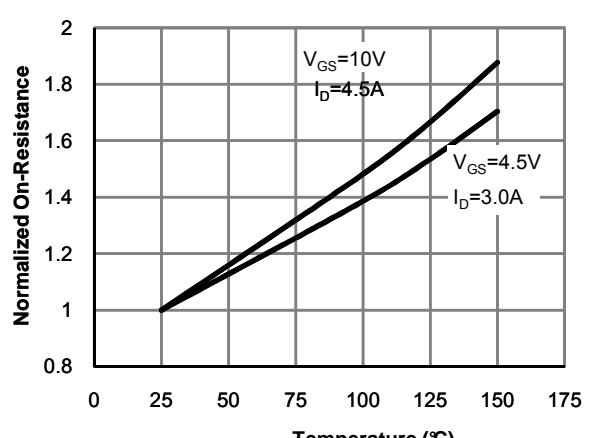


Figure 4: On-Resistance vs. Junction Temperature

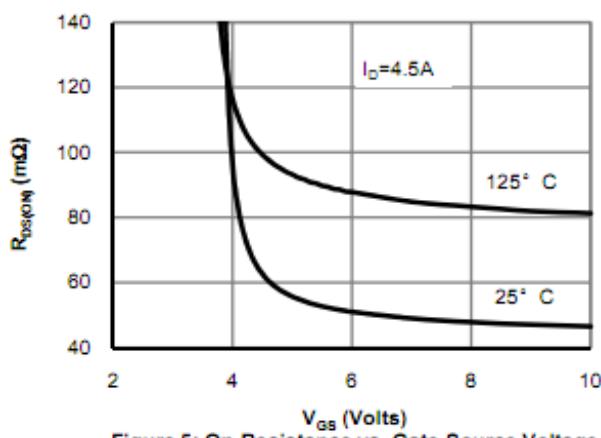


Figure 5: On-Resistance vs. Gate-Source Voltage

P-Channel Electrical Characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified) P 沟道电气特性 25°C

Parameter 参数	符号	Test Condition 测试条件	最小值	典型值	最大值	单位
Static 静态参数						
Drain-Source Breakdown Voltage 漏源击穿电压	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-60			V
Drain-Source On-State Resistance 漏源导通电阻	$R_{\text{DS(on)}}$	$V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -3.2\text{A}$		95	110	$\text{m}\Omega$
Drain-Source On-State Resistance 漏源导通电阻	$R_{\text{DS(on)}}$	$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -2.8\text{A}$		125	140	$\text{m}\Omega$
Gate Threshold Voltage 栅源电压	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250\mu\text{A}$	-1	-2.5	-4	V
Zero Gate Voltage Drain Current 0 棚压漏极电流	I_{DSS}	$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate Body Leakage 漏极短路时截止栅电流	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	nA
Forward Transconductance 正向跨导	g_{fs}	$V_{\text{DS}} = -5\text{V}, I_{\text{D}} = -3.2\text{A}$		5		S
Dynamic³⁾ 动态参数						
Total Gate Charge 栅极总电荷	Q_g	$V_{\text{DS}} = -30\text{V}, I_{\text{D}} = -3.2\text{A}$ $V_{\text{GS}} = -10\text{V}$		12.7		nC
Gate-Source Charge 栅-源极电荷	Q_{gs}			2.4		
Gate-Drain Charge 栅-漏极电荷	Q_{gd}			2.65		
Turn-On Delay Time 导通延迟时间	$t_{\text{d(on)}}$	$V_{\text{DD}} = -30\text{V}, R_L = 10\Omega$ $I_{\text{D}} = -3.2\text{A}, V_{\text{GEN}} = -10\text{V}$ $R_G = 3\Omega$		16.5		ns
Turn-On Rise Time 导通上升时间	t_r			5.5		
Turn-Off Delay Time 关断延迟时间	$t_{\text{d(off)}}$			31.5		
Turn-Off Fall Time 关断下降时间	t_f			7.9		
Input Capacitance 输入电容	C_{iss}	$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$ $f = 1.0\text{MHz}$		737		pF
Output Capacitance 输出电容	C_{oss}			64		
Reverse Transfer Capacitance 反向传输电容	C_{rss}			32		
Source-Drain Diode 源漏二极管参数						
Max. Diode Forward Current 最大正向电流	I_s				-2.3	A
Diode Forward Voltage 正向电压	V_{SD}	$I_s = -1.0\text{A}, V_{\text{GS}} = 0\text{V}$			-1.2	V

P-Channel

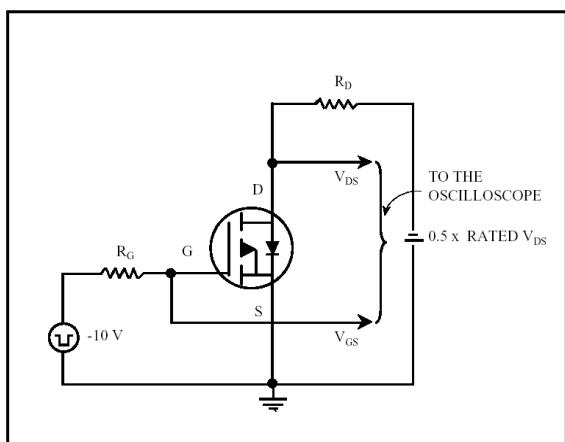


Fig 13. Switching Time Circuit

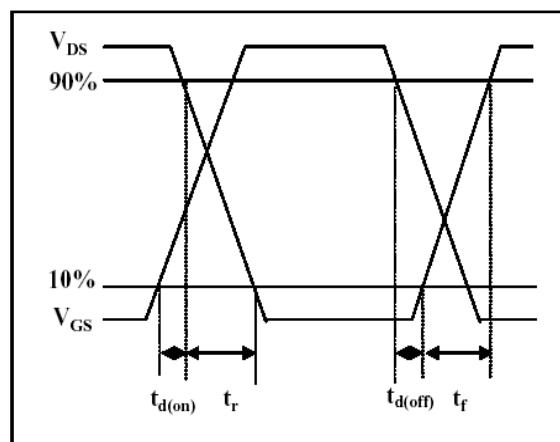


Fig 14. Switching Time Waveform

P-Channel Characteristics Curve P 沟道电气性能特征曲线

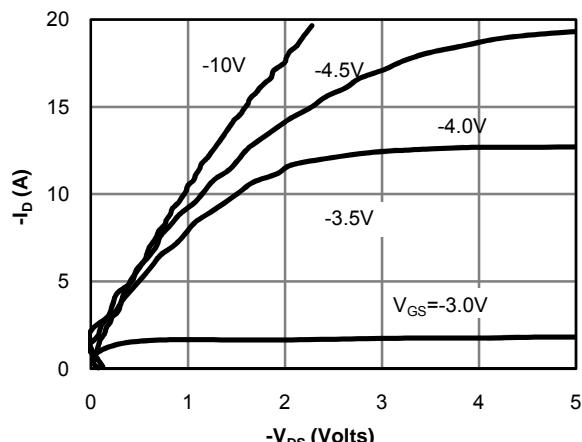


Fig 1: On-Region Characteristics

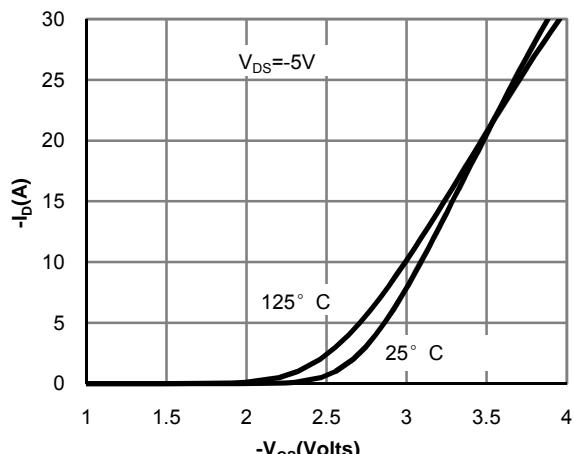


Figure 2: Transfer Characteristics

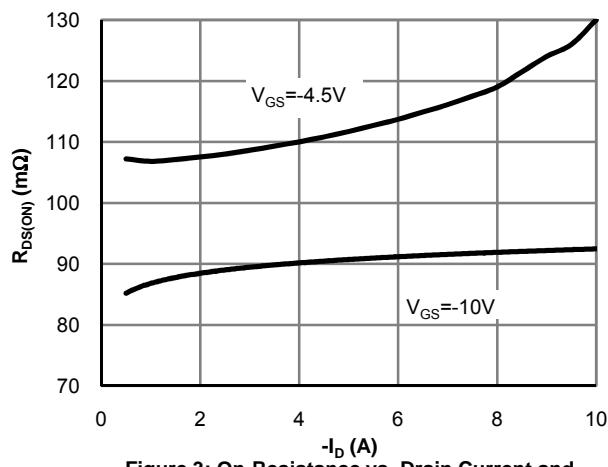


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

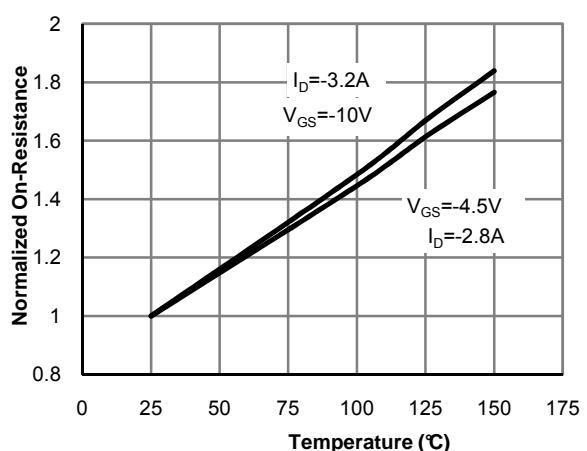


Figure 4: On-Resistance vs. Junction Temperature

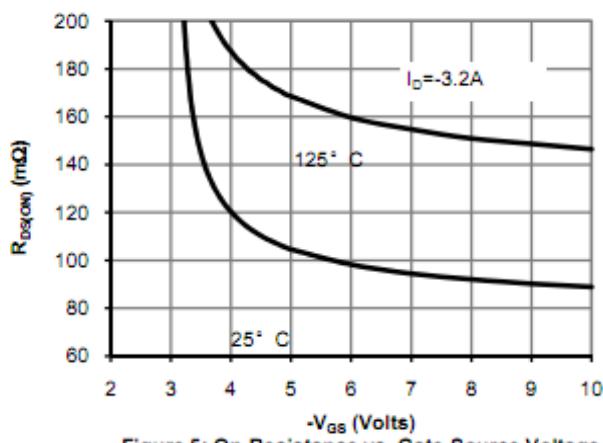


Figure 5: On-Resistance vs. Gate-Source Voltage